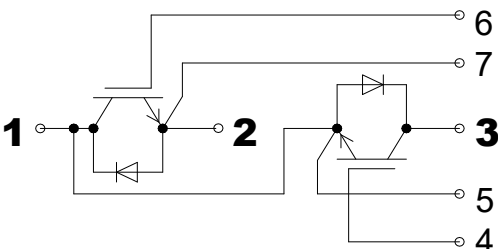


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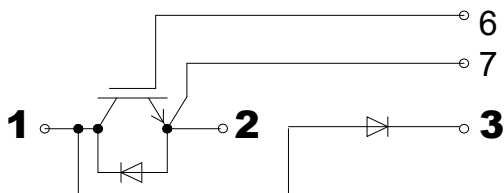
Ultra Fast IGBT Modules



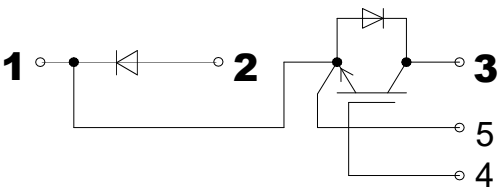
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SGD150N125UC2



SDG150N125UC2



Symbol	Test Condition	Value	Unit
IGBT			
V _{CES}		1200	V
I _C	T _C = 25(100)°C per chip	150(100)	A
V _{GES}		±20	V
T _{vj} (T _{stg})		-40 ~ +150(125) °C	
P _{tot}		450	W
INVERSE DIODE			
I _F	T _C =25(100)°C per chip	150(100)	A
I _{FM}		200	A
V _{RRM}		1200	V
i ² t	T _j =125°C, t=10ms, V _R =0V	2000	A ² s



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Symbol	Test Conditions	Min	Typ	Max	Unit
IGBT Tc = 25°C unless otherwise specified					
VGE(th)	VGE=VCE, IC=2mA	4.5	5.5	6.5	V
ICES	VGE = 0; VCE=VCES; Tj=25(125)°C		0.15	0.5	mA
VCE(TO)	Tj=25(125)°C		1.4(1.6)	1.6(1.8)	V
rCE	VGE=15V		11(15)	14(19)	mΩ
VCE(sat)	IC=100A; VGE=15V; chip level		3.3	3.7	V
Cies	VGE=0V, VCE=25V, f=1MHz		6.0		nF
Coes			0.80		
Cres			0.40		
LCE				30	nH
RCC'+EE'	Termial to Case, Tc=25°C		0.35		mΩ
td(on)	Vcc = 600V, IC = 100A RGON = RGOFF = 10Ω Tj=125°C VGE=±15V		25		ns
tr			50		ns
td(off)			290		ns
tf			90		ns
Eon/Eoff			4.50/2.30		mJ
INVERSE DIODE Tc = 25°C unless otherwise specified					
VF	IF =100A; VGE=0V; Tj = 25°C		1.9	2.2	V
Qrr	IF=50A; VR=300V; Tj=25°C di/dt = 600A/us, VGE=-15V		8.5		μC
IRRM			75		A
Erec			2.30		mJ
THERMAL CHARACTERISTICS					
Rth(j-c)	per IGBT			0.31	K/W
Rth(j-c)D	per FRD			0.45	K/W
Mechanical Data					
Ms		2.5		4	Nm
Weight			158		g

Features

- NPT Technology IGBT
- Fast Recovery Free Wheeling Diode
- Low Switching Losses
- $V_{ce(sat)}$ with positive temperature coefficient
- Fast Switching and short tail current
- Switched mode power supplies at $f_{sw}>20KHz$
- Resonant inverters up to 100KHz
- Electronic Welders at $f_{sw}>20KHz$

Application

- Welding inverters
- Inductive Heating

Advantages

- Space and weight savings
- Reduced protection circuits

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Fig 1. output characteristic IGBT,
 $I_c=f(V_{CE}), V_{GE}=15V$

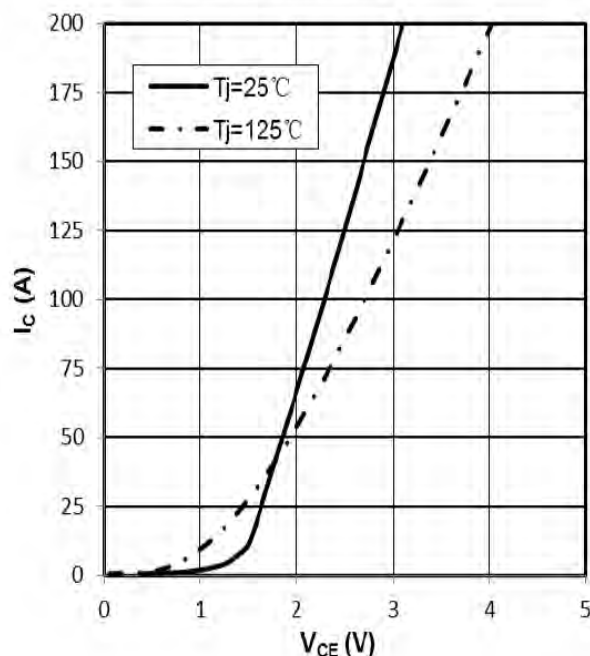


Fig 2. output characteristic IGBT,
 $I_c=f(V_{CE}), T_j=125^\circ\text{C}$

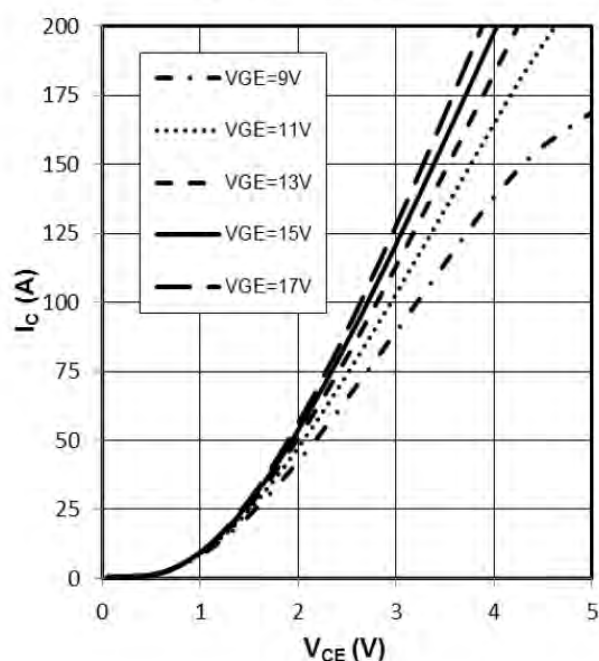


Fig 3. transfer characteristic IGBT,
 $I_c=f(V_{GE}), V_{CE}=20V$

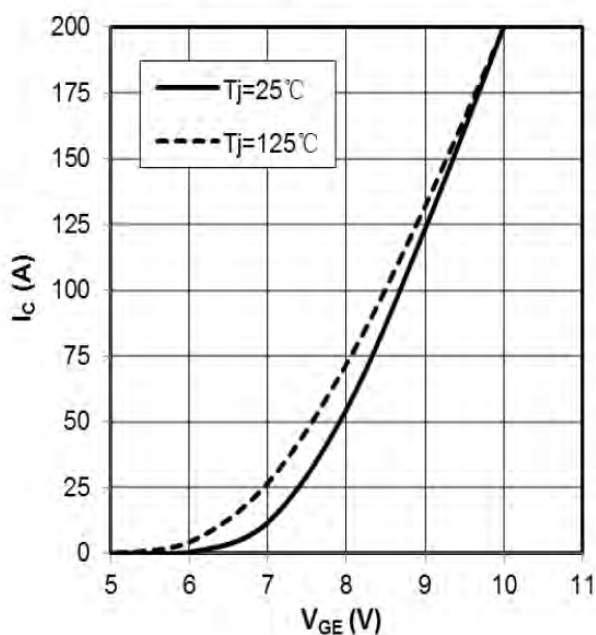
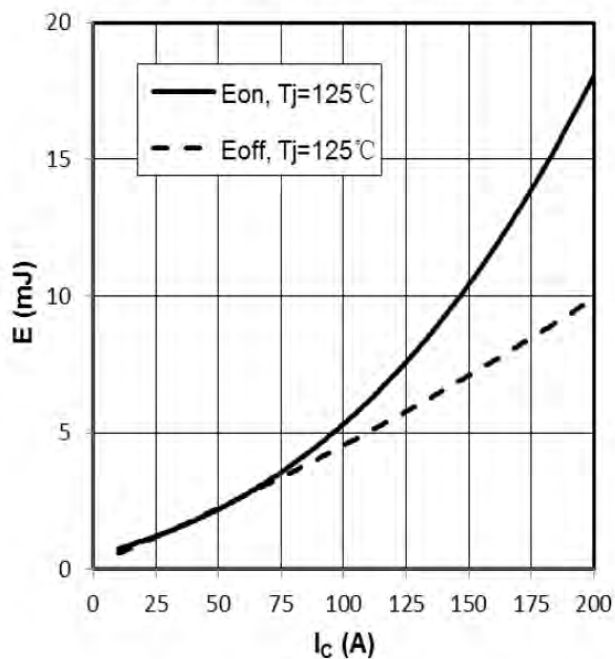


Fig 4. switching losses IGBT, $E_{on}=f(I_c), E_{off}=f(I_c)$,
 $V_{GE}=\pm 15V, R_{Gon}=5.6\Omega, R_{Goff}=5.6\Omega, V_{CE}=600V$



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Fig 5. switching losses IGBT,
 $E_{on}=f(R_g), E_{off}=f(R_g), V_{GE}=\pm 15V, I_C=100A, V_{CE}=600V$

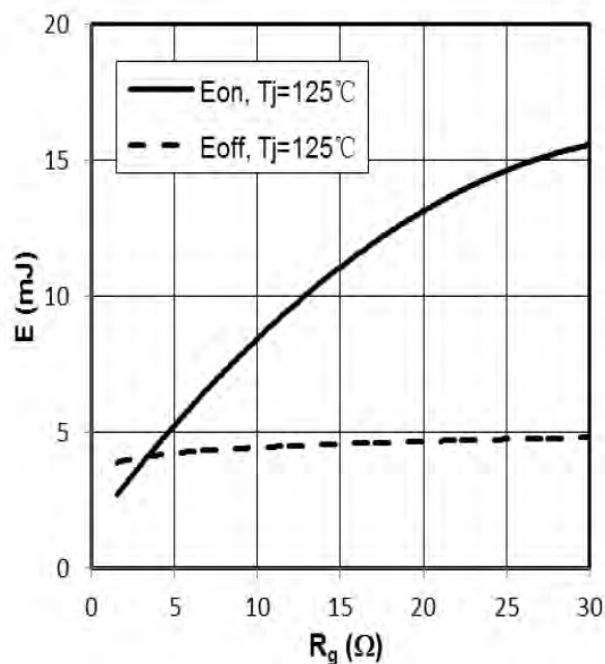


Fig 6. transient thermal impedance IGBT, $Z_{thjc}=f(t)$

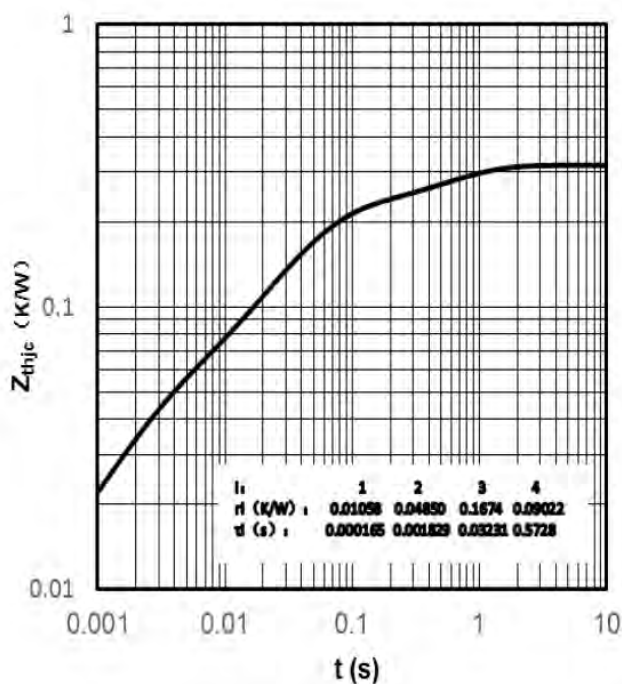


Fig 7. reverse bias safe operating area IGBT,
 $I_C=f(V_{CE}), V_{GE}=\pm 15V, R_{goff}=5.6\Omega, T_{vj}=125^\circ C$

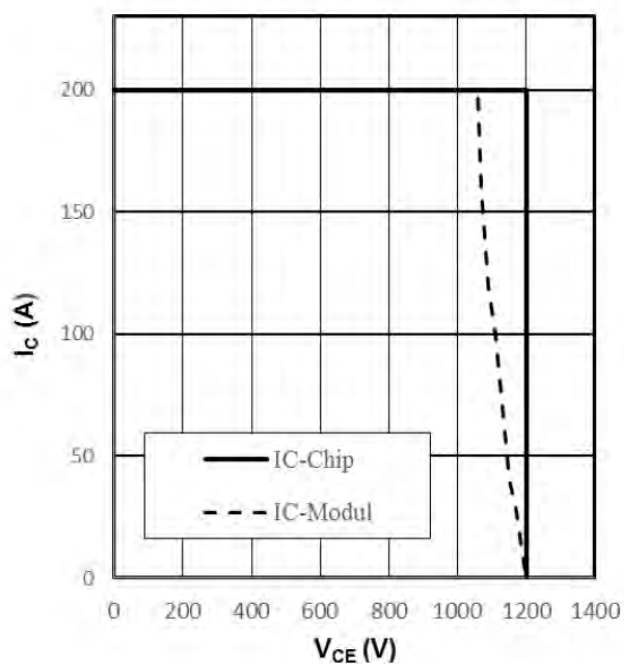
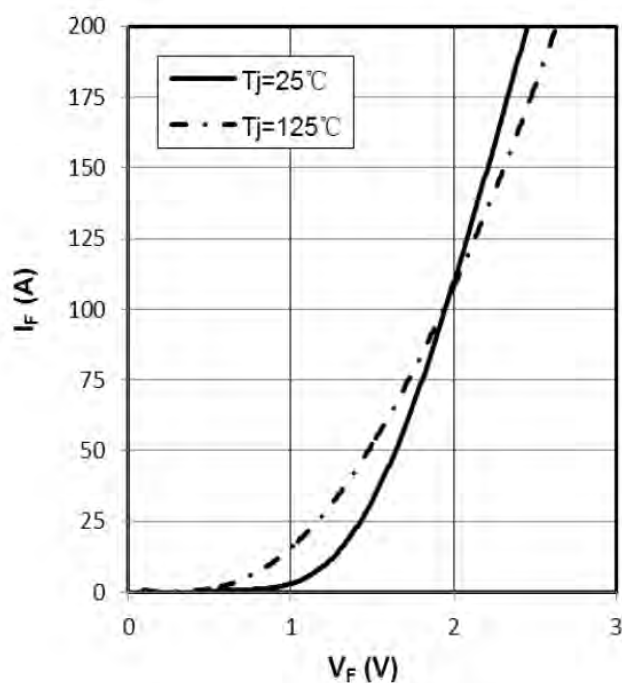


Fig 8. forward characteristic of Diode, $I_F=f(V_F)$



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Fig 9. switching losses Diode,
 $E_{rr}=f(I_F), R_{Gon}=7.5\Omega, V_{CE}=600V$

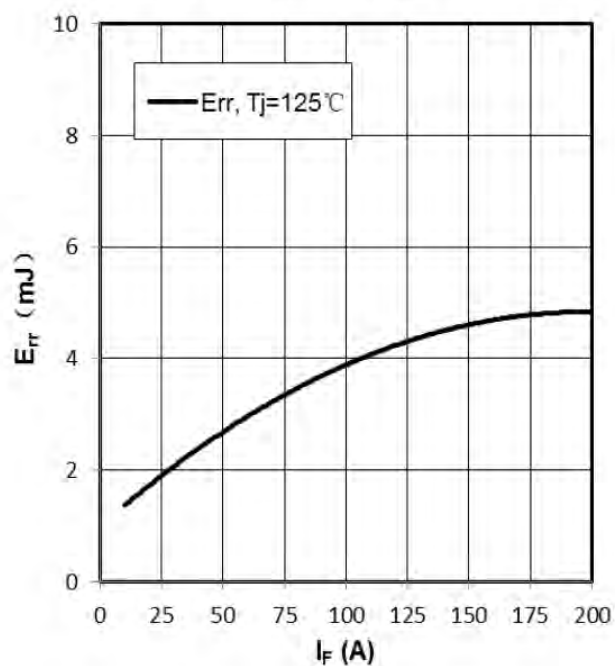
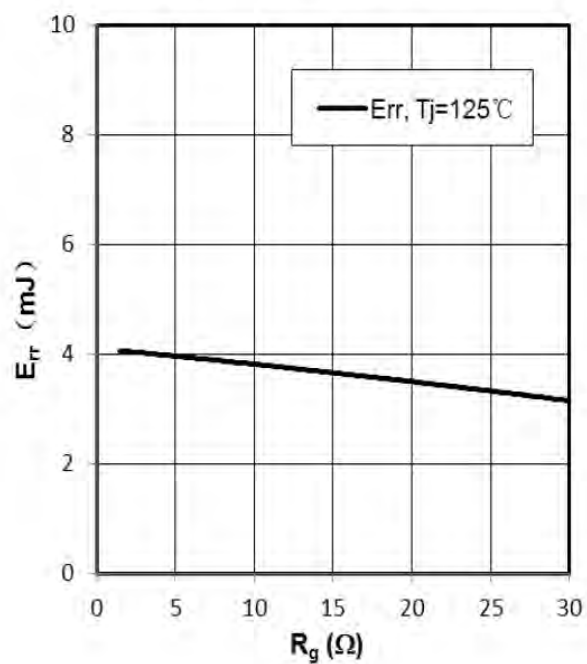


Fig 10. switching losses Diode,
 $E_{rr}=f(R_g), I_F=100A, V_{CE}=600V$



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